



Integrated  
Circuit  
Systems, Inc.

# ICS839893I

## LOW SKEW, 1-TO-13 LVCMS/LVTTL BUFFER DIVIDER

### GENERAL DESCRIPTION

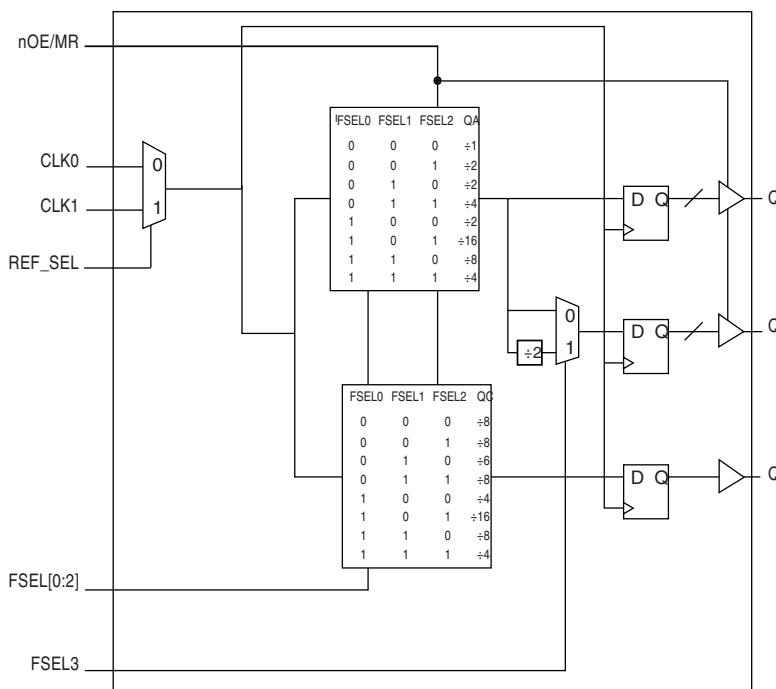


The ICS839893I is a high-performance one to thirteen LVCMS/LVTTL buffer/divider and is a member of the HiPerClock™ family of High Performance Clock Solutions from ICS. The device has two selectable LVCMS/LVTTL clock inputs and it generates 13 new LVCMS/LVTTL clock outputs. The first bank of six outputs offers divide-by-1, 2, 4, 8 or 16. The second bank of six outputs can be configured to the same divide ratio as the first bank, or with an additional divide-by-two. The first two banks can be placed into a high-impedance output state with the assertion of a LOW on the nOE/MR input. One additional output can be configured to divide-by-4, 6, 8 or 16. This device is functional with full 3.3V or full 2.5V supplies.

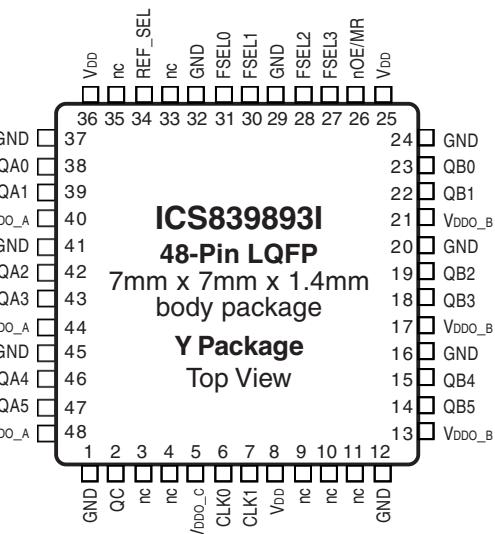
### FEATURES

- 13 LVCMS/LVTTL outputs: 3 banks (6, 6, 1 outputs per bank respectively)
- Selectable CLK0 or CLK1 LVCMS/LVTTL clock inputs
- CLK0, CLK1 supports the following input types: LVCMS, LVTTL
- Maximum output frequency: 250MHz
- Output skew: 40ps (maximum), within bank
- Full 3.3V or 2.5V operating supply
- -40°C to 85°C ambient operating temperature
- Available in both, Standard and RoHS/Lead-Free compliant packages

### SIMPLIFIED BLOCK DIAGRAM



### PIN ASSIGNMENT





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**TABLE 1. PIN DESCRIPTIONS**

Number	Name	Type	Description
1, 12, 16, 20, 24, 29, 32, 37, 41, 45	GND	Power	Supply ground.
2	QC	Output	Bank C output. LVC MOS / LVTTL interface levels.
3, 4, 9, 10, 11, 33, 35	nc	Unused	No connect.
5	V <sub>DDO_C</sub>	Power	Output supply pin for Bank C output.
6, 7	CLK0, CLK1	Input Pulldown	LVC MOS / LVTTL clock inputs.
8, 25, 36	V <sub>DD</sub>	Power	Core supply pins.
13, 17, 21	V <sub>DDO_B</sub>	Power	Output supply pins for Bank B outputs.
14, 15, 18, 19, 22, 23	QB5, QB4 QB3, QB2 QB1, QB0	Output	Bank B outputs. LVC MOS / LVTTL interface levels.
26	nOE/MR	Input Pulldown	Active High Master Reset. Active Low Output Enable. When logic LOW, the internal dividers and the outputs are enabled. When logic HIGH, the internal dividers are reset and the outputs are tri-stated (HiZ). LVC MOS / LVTTL interface levels.
27, 28, 30, 31	FSEL3, FSEL2, FSEL1, FSEL0	Input Pulldown	Clock frequency selection and configuration of clock divider modes. LVC MOS / LVTTL interface levels.
34	REF_SEL	Input Pulldown	Selects the primary reference clock. When LOW, selects CLK0 as the primary clock source. When HIGH, selects CLK1 as the primary clock source. LVC MOS / LVTTL interface levels.
38, 39 42, 43, 46, 47	QA0, QA1, QA2, QA3, QA4, QA5	Output	Bank A outputs. LVC MOS / LVTTL interface levels.
40, 44, 48	V <sub>DDO_A</sub>	Power	Output supply pins for Bank A outputs.

NOTE: Pulldown refers to internal input resistors. See Table 2, Pin Characteristics, for typical values.

**TABLE 2. PIN CHARACTERISTICS**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C <sub>IN</sub>	Input Capacitance			4		pF
R <sub>PULLDOWN</sub>	Input Pulldown Resistor			51		kΩ
C <sub>PD</sub>	Power Dissipation Capacitance (per output)	V <sub>DD</sub> = V <sub>DDA</sub> = V <sub>DDO_x</sub> = 3.465V		9		pF
		V <sub>DD</sub> = V <sub>DDA</sub> = V <sub>DDO_x</sub> = 2.625V		9		pF
R <sub>OUT</sub>	Output Impedance			14		Ω

NOTE: V<sub>DDO\_X</sub> denotes V<sub>DDO\_A</sub>, V<sub>DDO\_B</sub>, V<sub>DDO\_C</sub>.



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TABLE 3. CLOCK FREQUENCY FUNCTION TABLE

Inputs				fREF Range (MHz)	Outputs		
FSEL0	FSEL1	FSEL2	FSEL3		QAx	QBx	QC
					fQAx (MHz)	fQBx (MHz)	fQC0 (MHz)
0	0	0	0	DC - 250	fREF ÷ 1	fREF ÷ 1	
0	0	0	1			fREF ÷ 2	fREF ÷ 8
0	0	1	0	DC - 250	fREF ÷ 2	fREF ÷ 2	
0	0	1	1			fREF ÷ 4	fREF ÷ 8
0	1	0	0	DC - 250	fREF ÷ 2	fREF ÷ 2	
0	1	0	1			fREF ÷ 4	fREF ÷ 6
0	1	1	0	DC - 250	fREF ÷ 4	fREF ÷ 4	
0	1	1	1			fREF ÷ 8	fREF ÷ 8
1	0	0	0	DC - 250	fREF ÷ 2	fREF ÷ 2	
1	0	0	1			fREF ÷ 4	fREF ÷ 4
1	0	1	0	DC - 250	fREF ÷ 16	fREF ÷ 16	
1	0	1	1			fREF ÷ 32	fREF ÷ 16
1	1	0	0	DC - 250	fREF ÷ 8	fREF ÷ 8	
1	1	0	1			fREF ÷ 16	fREF ÷ 8
1	1	1	0	DC - 250	fREF ÷ 4	fREF ÷ 4	
1	1	1	1			fREF ÷ 8	fREF ÷ 4



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#### Absolute Maximum Ratings

Supply Voltage, $V_{DD}$	4.6V
Inputs, $V_I$	-0.5V to $V_{DD} + 0.5$ V
Outputs, $V_O$	-0.5V to $V_{DDO_X} + 0.5$ V
Package Thermal Impedance, $\theta_{JA}$	47.9°C/W (0 lfpm)
Storage Temperature, $T_{STG}$	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the DC Characteristics or AC Characteristics is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

**TABLE 4A. POWER SUPPLY DC CHARACTERISTICS,  $V_{DD} = V_{DDO_A} = V_{DDO_B} = V_{DDO_C} = 3.3V \pm 5\%$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$V_{DD}$	Core Supply Voltage		3.135	3.3	3.465	V
$V_{DDO_A},$ $V_{DDO_B},$ $V_{DDO_C}$	Output Supply Voltage		3.135	3.3	3.465	V
$I_{DD}$	Power Supply Current				155	mA
$I_{DDO_A},$ $I_{DDO_B},$ $I_{DDO_C}$	Output Supply Current				20	mA

**TABLE 4B. POWER SUPPLY DC CHARACTERISTICS,  $V_{DD} = V_{DDO_A} = V_{DDO_B} = V_{DDO_C} = 2.5 \pm 5\%$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$V_{DD}$	Core Supply Voltage		2.375	2.5	2.625	V
$V_{DDO_A},$ $V_{DDO_B},$ $V_{DDO_C}$	Output Supply Voltage		2.375	2.5	2.625	V
$I_{DD}$	Power Supply Current				150	mA
$I_{DDO_A},$ $I_{DDO_B},$ $I_{DDO_C}$	Output Supply Current				20	mA



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**TABLE 4C. LVC MOS/LVTTL DC CHARACTERISTICS,  $V_{DD} = V_{DDO_A} = V_{DDO_B} = V_{DDO_C} = 3.3V \pm 5\%$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$**

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
$V_{IH}$	Input High Voltage		$V_{DD} = 3.3V$	2		$V_{DD} + 0.3$	V
$V_{IL}$	Input Low Voltage		$V_{DD} = 3.3V$	-0.3		0.8	V
$I_{IH}$	Input High Current	CLK0, CLK1, nOE/MR, REF_SEL FSEL0:FSEL3	$V_{DD} = V_{IN} = 3.465V$			200	$\mu A$
$I_{IL}$	Input Low Current	CLK0, CLK1, nOE/MR, REF_SEL FSEL0:FSEL3	$V_{DD} = 3.465V, V_{IN} = 0V$	-5			$\mu A$
$V_{OH}$	Output High Voltage; NOTE 1			2.6			V
$V_{OL}$	Output Low Voltage; NOTE 1					0.5	V

Note 1: Outputs terminated with  $50\Omega$  to  $V_{DDO_X}/2$ . See Parameter Measurement Information, 3.3V Output Load Test Circuit diagram.

**TABLE 4D. LVC MOS/LVTTL DC CHARACTERISTICS,  $V_{DD} = V_{DDO_A} = V_{DDO_B} = V_{DDO_C} = 2.5V \pm 5\%$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$**

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
$V_{IH}$	Input High Voltage			1.7		$V_{DD} + 0.3$	V
$V_{IL}$	Input Low Voltage			-0.3		0.7	V
$I_{IH}$	Input High Current	CLK0, CLK1, nOE/MR, REF_SEL FSEL0:FSEL3	$V_{DD} = V_{IN} = 2.625V$			200	$\mu A$
$I_{IL}$	Input Low Current	CLK0, CLK1, nOE/MR, REF_SEL FSEL0:FSEL3	$V_{DD} = 2.625V, V_{IN} = 0V$	-5			$\mu A$
$V_{OH}$	Output High Voltage; NOTE 1			1.8			V
$V_{OL}$	Output Low Voltage; NOTE 1					0.5	V

Note 1: Outputs terminated with  $50\Omega$  to  $V_{DDO_X}/2$ . See Parameter Measurement Information, 2.5V Output Load Test Circuit diagram.



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**TABLE 5A. AC CHARACTERISTICS,  $V_{DD} = V_{DDO_A} = V_{DDO_B} = V_{DDO_C} = 3.3V \pm 5\%$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$f_{OUT}$	Output Frequency		DC		250	MHz
$f_{REF}$	Input Frequency		DC		250	MHz
$t_{PD}$	Propagation Delay; NOTE 1		4.5		6.5	ns
tsk(o)	Output Skew; NOTE 2	within bank			40	ps
		bank-to-bank	Excludes QC		115	ps
		any output to QC			465	ps
$t_R/t_F$	Output Rise/Fall Time	20% to 80%	250		600	ps
$t_{PZL}, t_{PZH}$	Output Enable Time				10	ns
$t_{PLZ}, t_{PHZ}$	Output Disable Time				10	ns
odc	Output Duty Cycle		47		53	%

All parameters measured at  $f_{MAX}$  unless noted otherwise.

NOTE 1: Measured from  $V_{DD}/2$  of the input to  $V_{DD}/2$  output crossing point.

**TABLE 5B. AC CHARACTERISTICS,  $V_{DD} = V_{DDO_A} = V_{DDO_B} = V_{DDO_C} = 2.5V \pm 5\%$ ,  $T_A = -40^\circ C$  TO  $85^\circ C$**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
$f_{OUT}$	Output Frequency		DC		250	MHz
$f_{REF}$	Input Frequency		DC		250	MHz
$t_{PD}$	Propagation Delay; NOTE 1		5		7	ns
tsk(o)	Output Skew; NOTE 2	within bank			40	ps
		bank-to-bank	Excludes QC		110	ps
		any output to QC			410	ps
$t_R/t_F$	Output Rise/Fall Time	20% to 80%	250		600	ps
$t_{PZL}, t_{PZH}$	Output Enable Time				10	ns
$t_{PLZ}, t_{PHZ}$	Output Disable Time				10	ns
odc	Output Duty Cycle		47		53	%

All parameters measured at  $f_{MAX}$  unless noted otherwise.

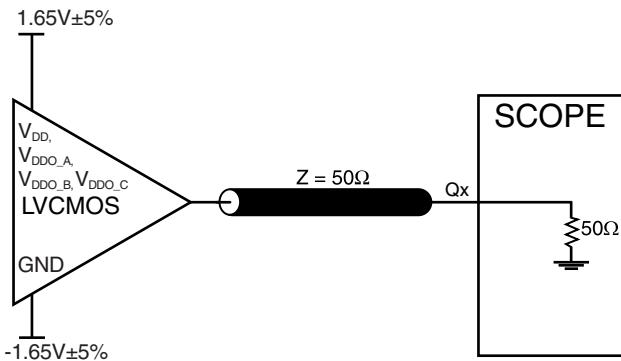
NOTE 1: Measured from  $V_{DD}/2$  of the input to  $V_{DD}/2$  output crossing point.



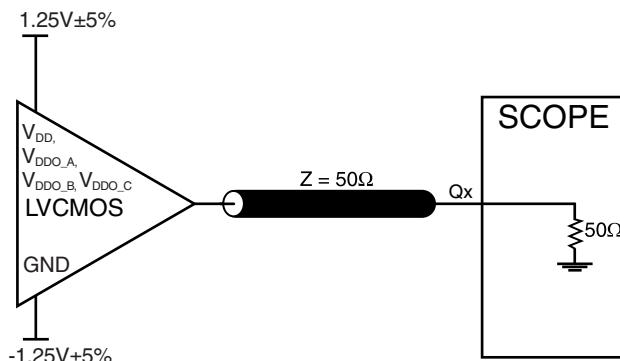
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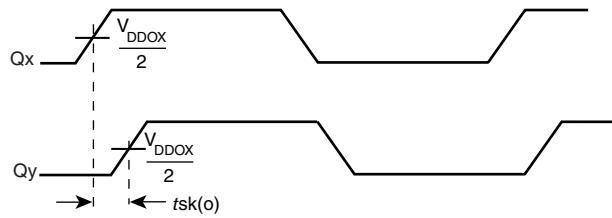
## PARAMETER MEASUREMENT INFORMATION



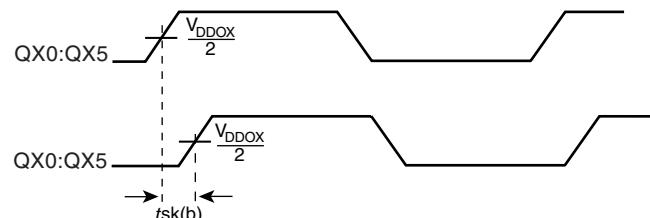
**3.3V CORE/3.3V OUTPUT LOAD AC TEST CIRCUIT**



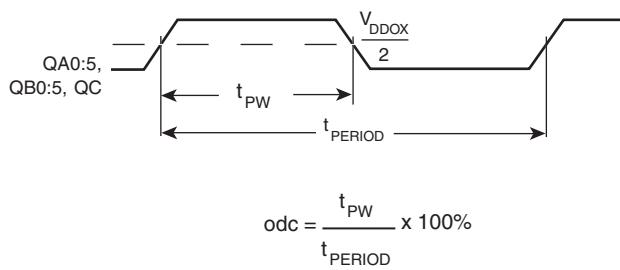
**2.5V CORE/2.5V OUTPUT LOAD AC TEST CIRCUIT**



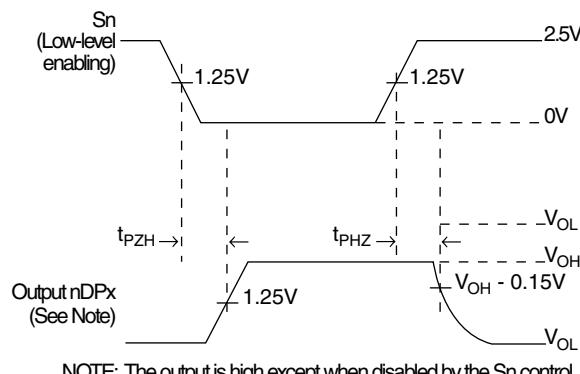
**OUTPUT SKEW**



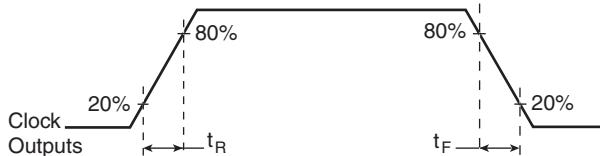
**BANK SKEW (where X denotes outputs in the same bank)**



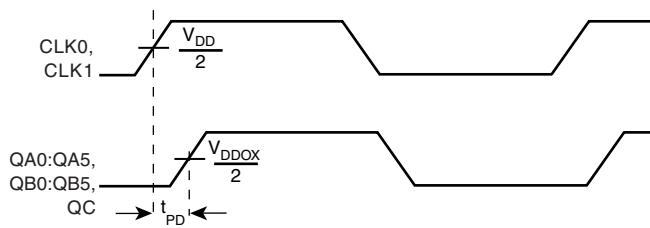
**OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD**



**OUTPUT ENABLE/DISABLE TIME**



**OUTPUT RISE/FALL TIME**



**PROPAGATION DELAY**



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## APPLICATION INFORMATION

### RECOMMENDATIONS FOR UNUSED INPUT AND OUTPUT PINS

#### INPUTS:

##### CLK INPUT:

For applications not requiring the use of the test clock, it can be left floating. Though not required, but for additional protection, a 1kΩ resistor can be tied from the CLK input to ground.

#### CONTROL PINS:

All control pins have internal pull-ups and pull-downs; additional resistance is not required but can be added for additional protection. A 1kΩ resistor can be used.

#### OUTPUTS:

##### LVC MOS OUTPUT:

All unused LVC MOS output can be left floating. We recommend that there is no trace attached.

## RELIABILITY INFORMATION

TABLE 6.  $\theta_{JA}$  vs. AIR FLOW TABLE FOR 48 LEAD LQFP

#### $\theta_{JA}$ by Velocity (Linear Feet per Minute)

	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	67.8°C/W	55.9°C/W	50.1°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	47.9°C/W	42.1°C/W	39.4°C/W

**NOTE:** Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

### TRANSISTOR COUNT

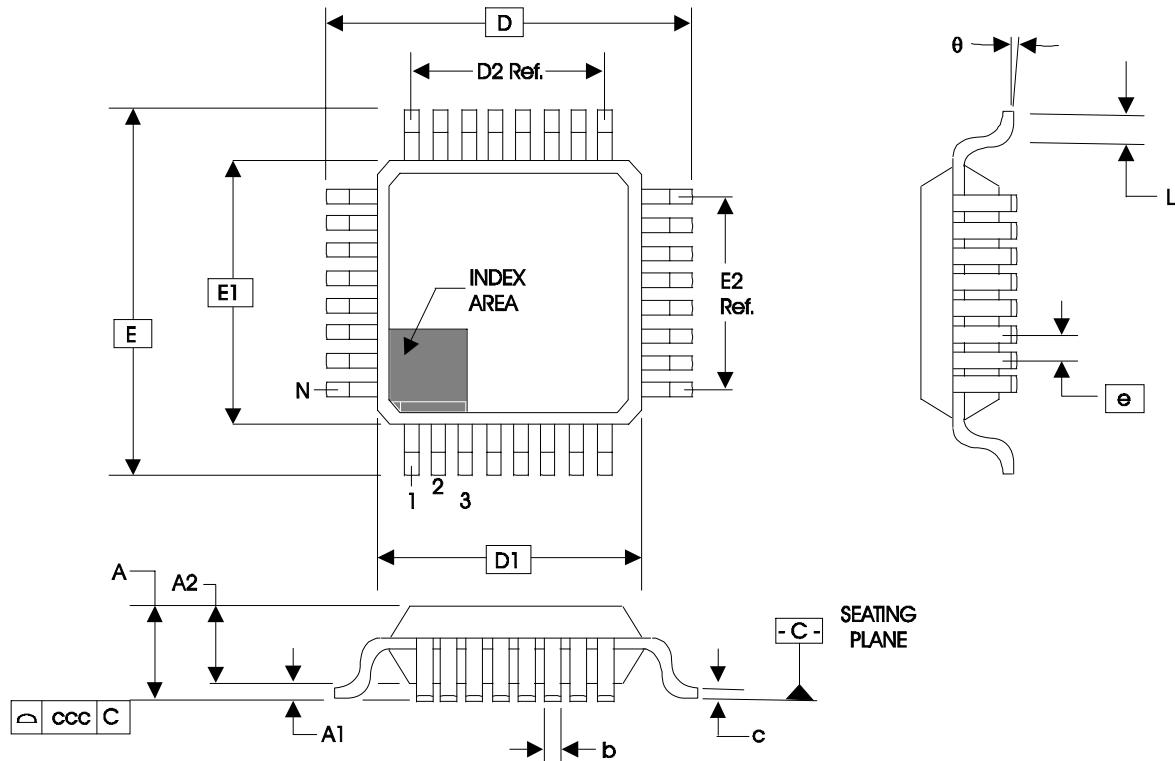
The transistor count for ICS839893I is: 4615



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**PACKAGE OUTLINE - Y SUFFIX FOR 48 LEAD LQFP**



**TABLE 7. PACKAGE DIMENSIONS**

SYMBOL	JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS		
	MINIMUM	NOMINAL	MAXIMUM
N	48		
A	--	--	1.60
A1	0.05	--	0.15
A2	1.35	1.40	1.45
b	0.17	0.22	0.27
c	0.09	--	0.20
D	9.00 BASIC		
D1	7.00 BASIC		
D2	5.50 Ref.		
E	9.00 BASIC		
E1	7.00 BASIC		
E2	5.50 Ref.		
e	0.50 BASIC		
L	0.45	0.60	0.75
θ	0°	--	7°
ccc	--	--	0.08

Reference Document: JEDEC Publication 95, MS-026



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**TABLE 8. ORDERING INFORMATION**

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
ICS839893AYI	ICS839893AYI	48 Lead LQFP	tray	-40°C to 85°C
ICS839893AYIT	ICS839893AYI	48 Lead LQFP	1000 tape & reel	-40°C to 85°C
ICS839893AYILF	TBD	48 Lead "Lead-Free" LQFP	tray	-40°C to 85°C
ICS839893AYILFT	TBD	48 Lead "Lead-Free" LQFP	1000 tape & reel	-40°C to 85°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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